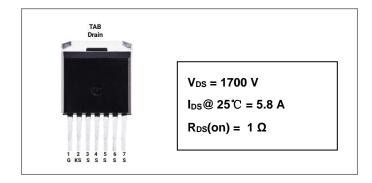




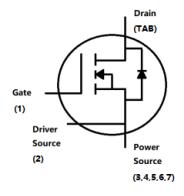
S1M1000170J 1700V SIC POWER MOSFET



Description

S1M1000170J is single SiC Power MOSFET packaged in TO-263-7 case. The device is a high voltage n-channel Enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S1M1000170J is ideal for energy sensitive, high frequency applications in challenging environments.

Circuit Diagram



Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance typ. RDS(on) = 1 Ω
- · Fast switching speed and low switching losses.
- Very fast and robust intrinsic body diode.
- · Process of non-bright tin electroplatin
- "-A" is an AEC-Q101 qualified device

Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)
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Maximum Ratings (T_A = 25 °C, unless otherwise specified)

Characteristics	Symbol	Conditions	Min.	Тур.	Max.	Units	Note
Drain - Source Voltage	V_{DSmax}	V _{GS} = 0 V, I _D = 100 μA			1700	V	
Gate - Source Voltage (dynamic)	V_{GSmax}	AC (f > 1 Hz)	-10		+25	V	
Gate - Source Voltage (static)	V_{GSop}	Static		-5 / +20		V	[1]
Continuous Drain Current	,	V _{GS} = 20 V, T _C = 25 °C		5.8		А	
Continuous Drain Current	I _D	V _{GS} = 20 V, T _C = 100 °C		4.1		A	
Pulsed Drain Current	I _{D(pulse)}	Pulse width t _P limited by T _{jmax}			15	А	
Power Dissipation	P _D	T _C = 25 °C			100	W	

^[1] Recommended turn off gate voltage is -4 V. Recommended turn on gate voltage is 18 V. Do not use with V_{GSON} < 12 V.



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Electrical Characteristics (T_A = 25 °C, unless otherwise specified)

Characteristics	Symbol	Conditions	Min.	Тур.	Max.	Units
Drain Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$	1700			V
	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 0.5 \text{ mA}$	2	3.2	4	V
Gate Threshold Voltage		$V_{DS} = V_{GS}, I_D = 0.5 \text{ mA}, T_J = 175 \text{ °C}$		2.4		V
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 1700 V, V _{GS} = 0 V		1	100	μΑ
Gate Source Leakage Current	lgss	V _{GS} = 20 V, V _{DS} = 0 V		10	250	nA
Drain Source On-State		V _{GS} = 20 V, I _D = 2 A		1	1.3	Ω
Resistance	R _{DS(on)}	V _{GS} = 20 V, I _D = 2 A, T _J = 175 °C		1.9		Ω
Teachandiatena	gfs	V _{DS} = 20 V, I _{DS} = 2 A		1		S
Transconductance		V _{DS} = 20 V, I _{DS} = 2 A, T _J = 175 °C		1.05		S
Input Capacitance	C _{ISS}	V _{GS} = 0 V		160		
Output Capacitance	Coss	V _{DS} = 1000 V		10		pF
Reverse Transfer Capacitance	Crss	V _{AC} = 25 mV		2		
Coss Stored Energy	Eoss	f = 1 MHz		4		μJ
Turn-On Switching Energy	Eon	V _{DS} = 1000 V, V _{GS} = -5 / 20 V		55		
Turn-Off Switching Energy	Eoff	$I_D = 2 \text{ A}, R_{G(ext)} = 2.5 \Omega, L = 99 \text{ uH}$		24		μЈ
Turn-On Delay Time	t _{d(on)}	V _{DS} = 1000 V, V _{GS} = -5 / 20 V		4		
Rise Time	tr	$I_D = 2 \text{ A}, R_{G(ext)} = 2.5 \Omega$		6		ns
Turn-Off Delay Time	t _{d(off)}	Inductive Load Timing relative to		8		

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Fall Time	t _f	VDS Per IEC60747-8-4 pg 83		77		
Internal Gate Resistance	R _{G(int)}	f = 1 MHz, AC = 25 mV		20		Ω
Gate to Source Charge	Q_{gs}	V _{DS} = 1700 V, V _{GS} = -5 / 20 V		2.5		
Gate to Drain Charge	Q_{gd}	I _D = 2 A		5.2		nC
Total Gate Charge	Q_g	Per IEC60747-8-4 pg 21		10		

Reverse Diode Characteristics (T_A = 25 °C, unless otherwise specified)

Characteristics	Symbol	Conditions	Тур.	Max.	Units
		V _{GS} = -5 V, I _{SD} = 1 A	4.6		V
Diode Forward Voltage	V_{SD}	V _{GS} = -5 V, I _{SD} = 1 A, T _J = 175 °C	4.3		V
Continuous Diode Forward Current	Is	V _{GS} = -5 V, T _C = 25 °C	9		А
Reverse Recovery Time	t _{rr}	V _{GS} = -5 V, I _{SD} = 2 A, T _J = 25 °C	6		ns
Reverse Recovery Charge	Q _{rr}	V _R = 1200 V	25		nC
Peak Reverse Recovery Current	I _{mm}	dif / dt = 2500 A / μs	7		А

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Thermal-Mechanical Specifications

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	R _в јс	DC operation	1.49	°C/W

Ordering Information

Device	Package	Shipping
S1M1000170J	TO-263-7	50pcs/tube
S1M1000170J	TO-263-7	800pcs/reel

Marking Diagram



Where XXXXX is YYWWL

S1M = Device Type

 $1000 = R_{DS}(on)$

170 = Reverse Voltage (1200V)

J = Package SSG = SSG YY = Year

WW = Week
L = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0





Ratings and Characteristics Curves

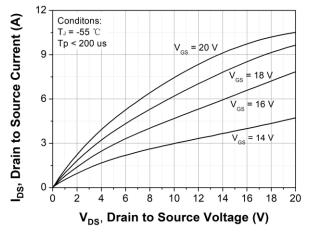


Figure 1. Output Characteristics T_J = -55 °C

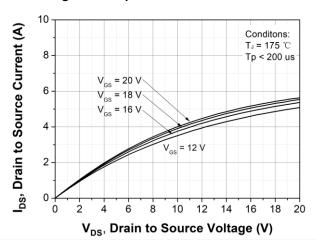


Figure 3. Output Characteristics T_J = 175 °C Conditions: On Resistance, Rds on (ohm) 3.5 V_{GS} = 20 V Tp < 200 us 3.0 2.5 T, = 175 °C 2.0 T_J = 25 ℃ 1.0 T, = -55 °C 0.5 0.0 -I_{DS}, Drain to Source Current (A)

Figure 5. On-Resistance vs. Drain Current For Various Temperatures

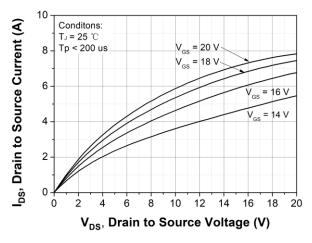


Figure 2. Output Characteristics T_J = 25 °C

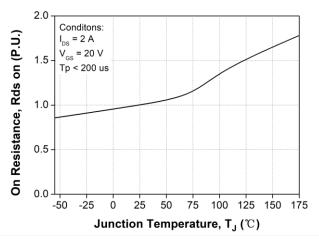


Figure 4. Normalized On-Resistance vs. Temperature

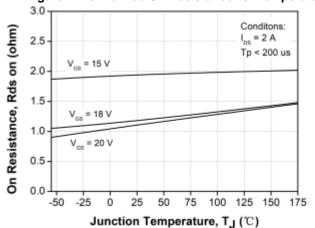


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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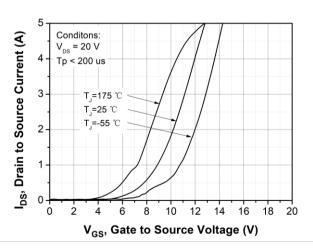


Figure 7. Transfer Characteristic for Various Junction Temperatures

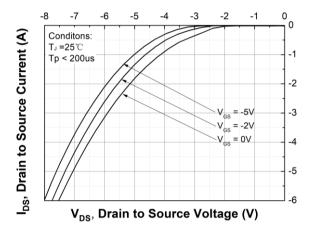


Figure 9. Body Diode Characteristic at T_J = 25 °C

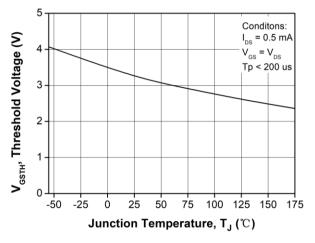


Figure 11. Threshold Voltage vs. Temperature

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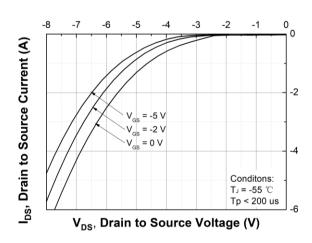


Figure 8. Body Diode Characteristic at T_J = -55 °C

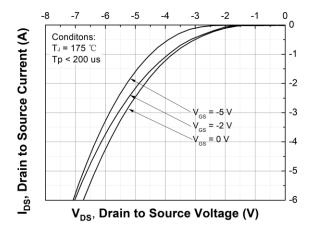


Figure 10. Body Diode Characteristic at T_J = 175 °C

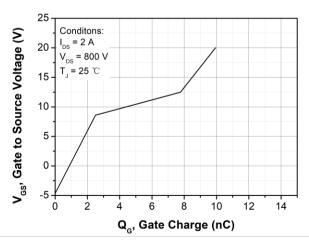


Figure 12. Gate Charge Characteristic

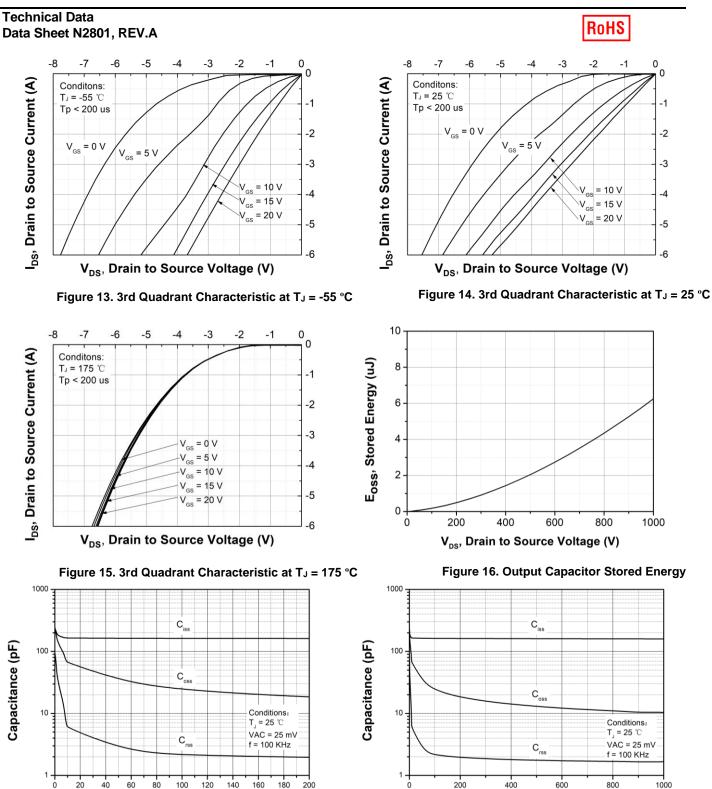
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V_{DS}, Drain to Source Voltage (V)

Figure 18. Capacitances vs. Drain-Source

Voltage (0 - 1000 V)





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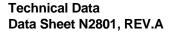
V_{ps}, Drain to Source Voltage (V)

Figure 17. Capacitances vs. Drain-Source

Voltage (0 - 200 V)

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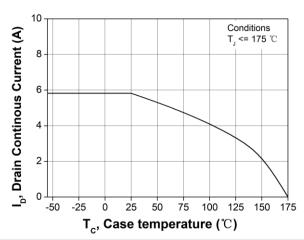


Figure 19. Continuous Drain Current Derating vs.

Case Temperature

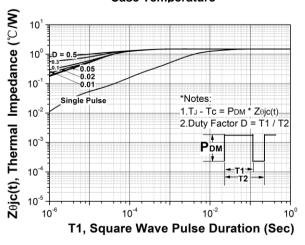


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

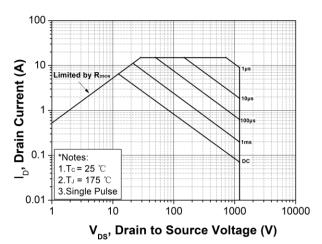


Figure 21. Transient Thermal Impedance (Junction - Case)

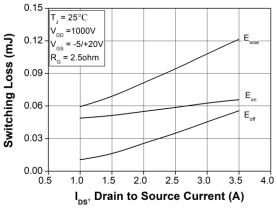


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 600V)

Figure 22. Safe Operating Area

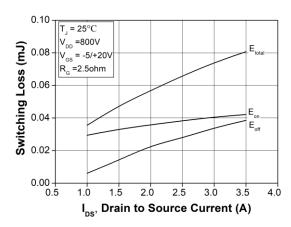


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

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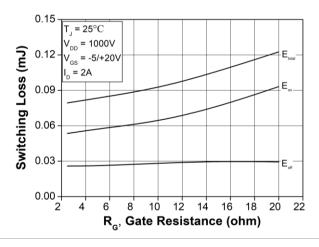


Figure 25. Clamped Inductive Switching Energy vs. R_{G(ext)}

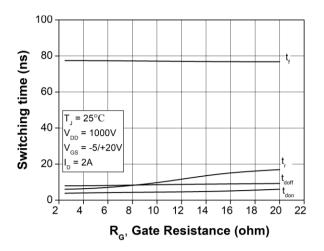


Figure 27. Switching Times vs. R_{G(ext)}

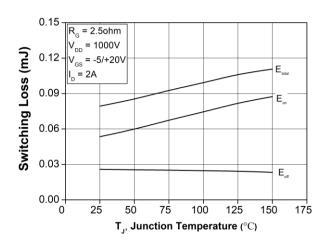


Figure 26. Clamped Inductive Switching Energy vs.
Temperature

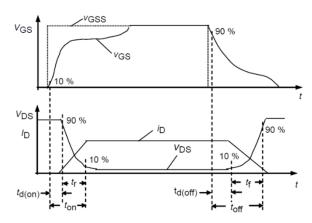
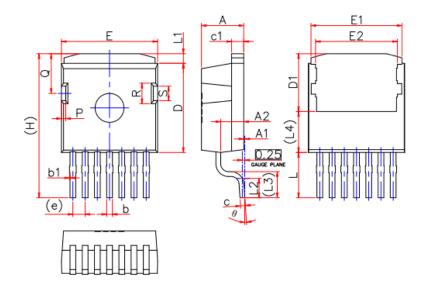


Figure 28. Switching Times Definition



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Mechanical Dimensions TO-263-7



SYMBOL	Millimeters				
STWIBOL	MIN.	TYP.	MAX.		
Α	4.300	4.400	4.500		
A1	0.000	0.100	0.200		
A2	2.300	2.400	2.500		
b	0.500	0.600	0.700		
b1	0.000	0.075	0.150		
С	0.400	0.500	0.5600		
c1	1.170	1.270	1.370		
D	9.050	9.250	9.450		
D1	5.900	6.000	6.100		
Е	9.800	10.000	10.200		
E1	9.360	9.460	9.560		
E2	8.400	8.500	8.600		
е		1.270 REF			
Н		15.000 REF			
L	4.200	4.700	5.200		
L1	0.700	1.000	1.300		
L2	1.700	2.000	2.300		
L3	2.700 REF				
L4	4.250 REF				
Р	0.350	0.450	0.550		
Q	4.020	4.120	4.220		
R	2.030	2.130	2.230		
S	1.400	1.500	1.600		
θ	0°	4°	8°		

S1M1000170J



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